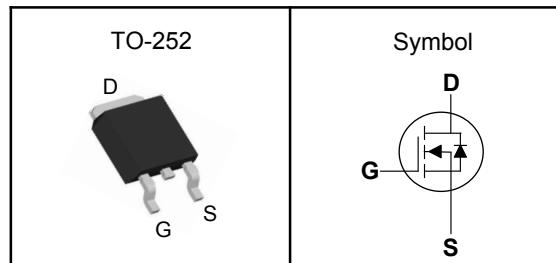


600V Super Junction Power MOSFET

Features

- Low drain-source on-resistance: $R_{DS(ON)}=0.32\Omega(\text{typ})$
- Easy to control gate switching
- Enhancement mode: $V_{th} = 3 \text{ to } 4V$
- 100% avalanche tested
- RoHS compliant

Pin Description



Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- Charger, Lighting

V_{DSS}	600	V
$R_{DS(ON)-\text{Typ}}$	320	$\text{m}\Omega$
I_D	11	A

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit	
V_{DSS}	Drain-Source Voltage	600	V	
V_{GSS}	Gate-Source Voltage	± 30	V	
T_J	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$	
E_{AS}	Single Pulse Avalanche Energy ^③	320	mJ	
$I_{DM}^{①}$	Pulse Drain Current Tested	30	A	
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	11	A
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	78	W

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case ₁	1.6	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C .

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

600V Super Junction Power MOSFET

Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	600	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=600\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	μA
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D=250\mu\text{A}$	3	---	4	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 30\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
$\text{R}_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=5.5\text{A}$	---	320	370	$\text{m}\Omega$
Dynamic Characteristics^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=100\text{V}$, Freq.=1MHz	---	797	---	pF
C_{oss}	Output Capacitance		---	30	---	
C_{rss}	Reverse Transfer Capacitance		---	4.2	---	
$\text{T}_{\text{d(on)}}$	Turn-on Delay Time	$\text{V}_{\text{DD}}=400\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_{\text{G}}=25\Omega$, $I_{\text{D}}=11\text{A}$	---	41	---	nS
T_r	Turn-on Rise Time		---	20	---	
$\text{T}_{\text{d(off)}}$	Turn-off Delay Time		---	120	---	
T_f	Turn-off Fall Time		---	20	---	
R_{g}	Gate Resistance	$f = 1.0\text{MHz}$, open drain	---	14	---	Ω
Q_{g}	Total Gate Charge	$\text{V}_{\text{DS}}=400\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=11\text{A}$	---	20	---	nC
Q_{gs}	Gate-Source Charge		---	4.2	---	
Q_{gd}	Gate-Drain Charge		---	7	---	
Source-Drain Characteristics ($T_J=25^\circ\text{C}$)						
$\text{V}_{\text{SD}}^{④}$	Diode Forward Voltage	$I_{\text{S}}=11\text{A}$, $V_{\text{GS}}=0\text{V}$	---	0.9	1.2	V
t_{rr}	Reverse Recovery Time	$\text{V}_{\text{R}}=400\text{V}$, $I_{\text{F}}=11\text{A}$, $d\text{i}/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	330	---	nS
Q_{rr}	Reverse Recovery Charge		---	3.5	---	nC

Note ④ : Pulse test (pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

600V Super Junction Power MOSFET

Typical Characteristics

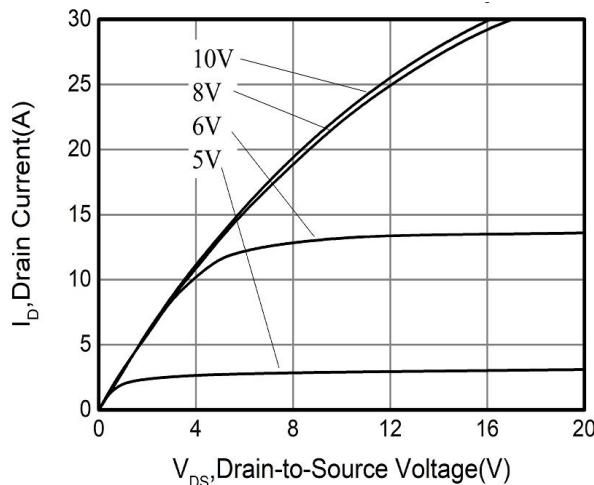


Figure 1. Output Characteristics

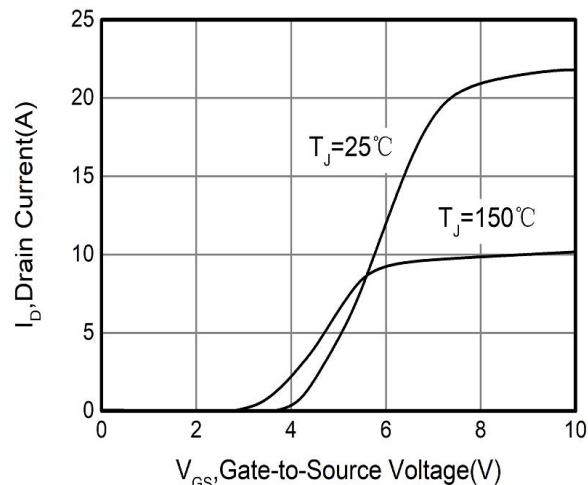


Figure 2. Transfer Characteristics

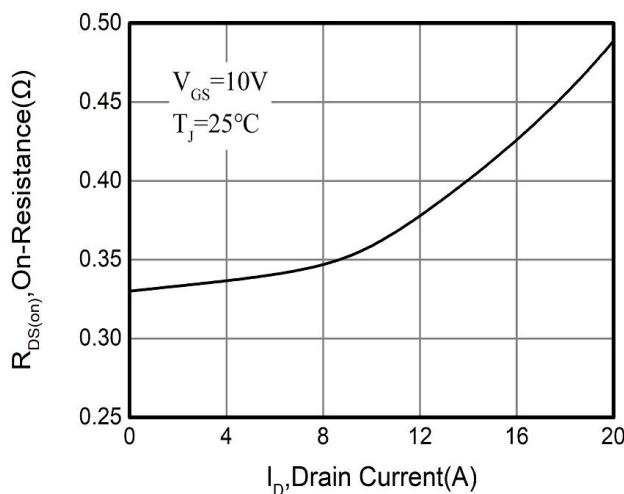


Figure 3. On-Resistance vs. Drain Current

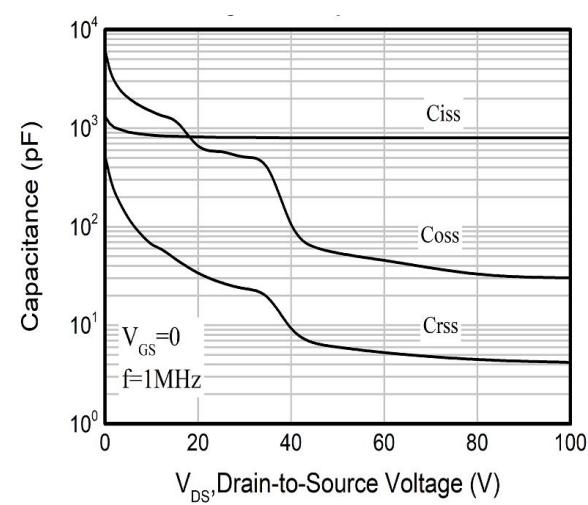
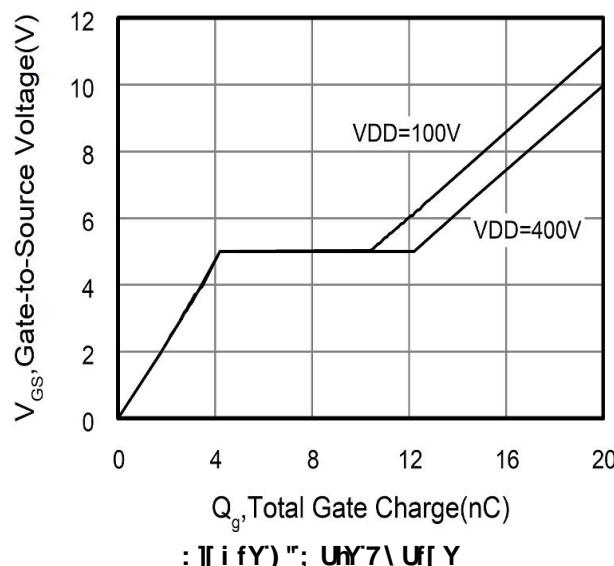


Figure 4. Capacitance



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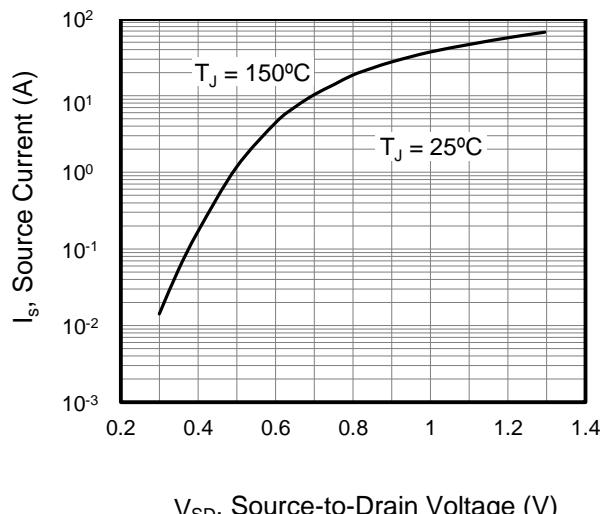
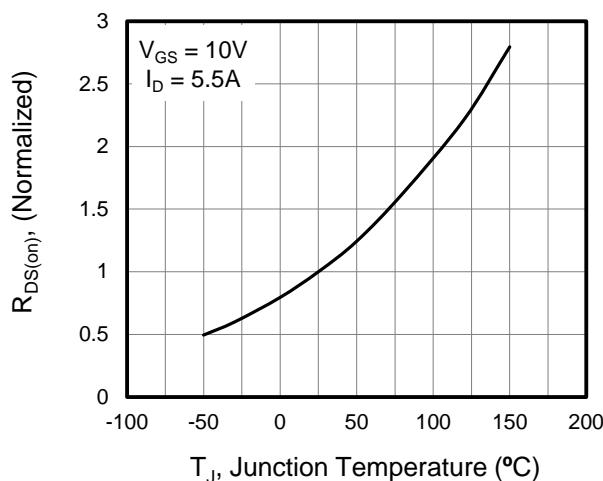
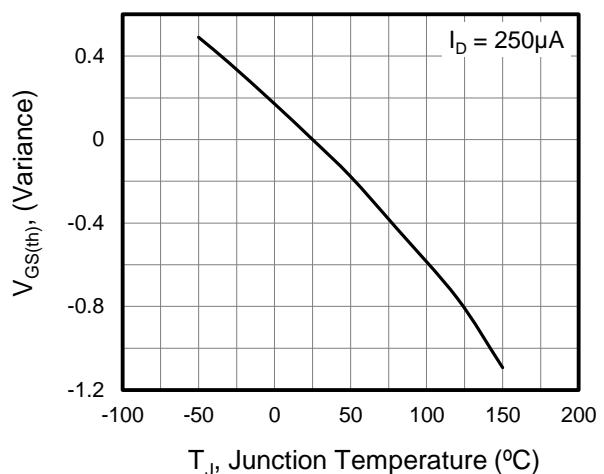


Figure 6. Body Diode Forward Voltage

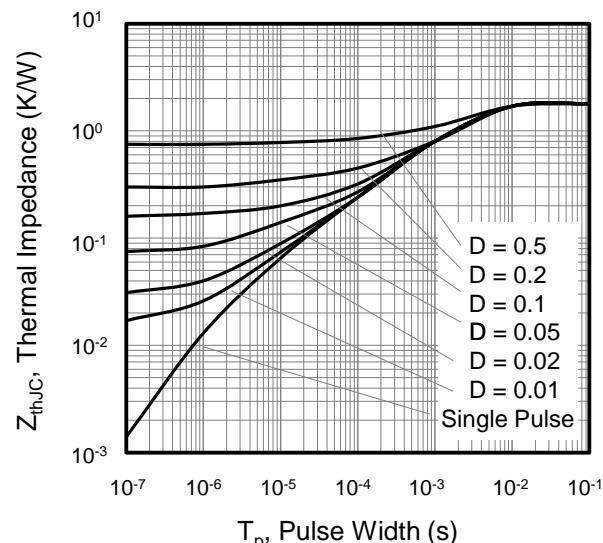
600V Super Junction Power MOSFET



**Figure 7. On-Resistance vs.
Junction Temperature**



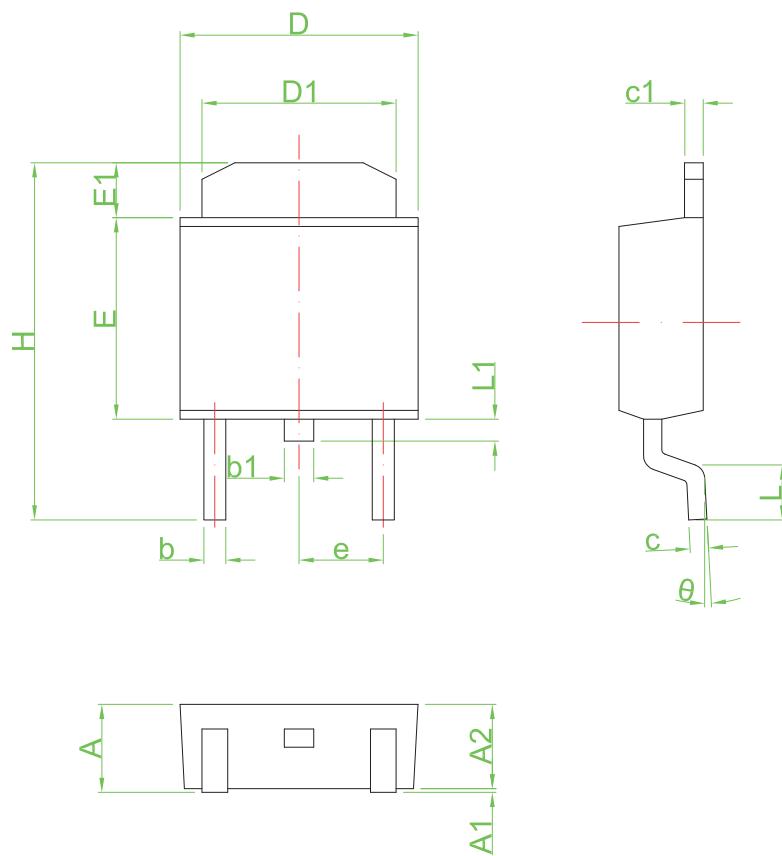
**Figure 8. Threshold Voltage vs.
Junction Temperature**



**Figure 9. Transient Thermal Impedance
TO-252, TO-220**

600V Super Junction Power MOSFET

TO-252 Package Outline Dimensions



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	2.25	2.65	0.089	0.104
A1	0.00	0.15	0.000	0.006
A2	2.20	2.40	0.087	0.094
b	0.50	0.70	0.020	0.028
b1	0.70	0.90	0.028	0.035
c	0.46	0.66	0.018	0.026
c1	0.46	0.66	0.018	0.026
D	6.30	6.70	0.248	0.264
D1	5.20	5.40	0.205	0.213
E	5.30	5.70	0.209	0.224
E1	1.40	1.60	0.055	0.063
H	9.40	9.90	0.370	0.390
e	2.30 TYP		0.09 TYP	
L	1.40	1.77	0.055	0.070
L1	0.50	0.70	0.020	0.028
θ	0°	8°	0°	8°